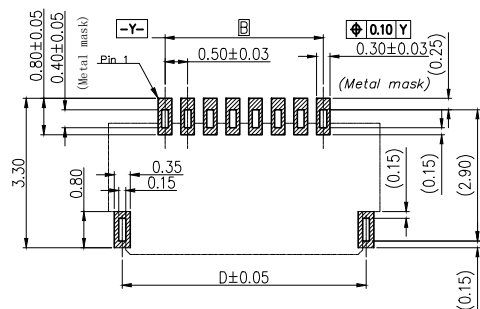
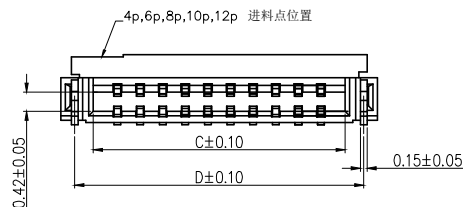
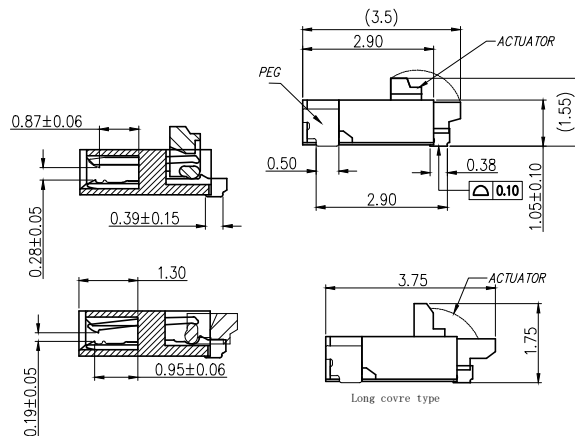
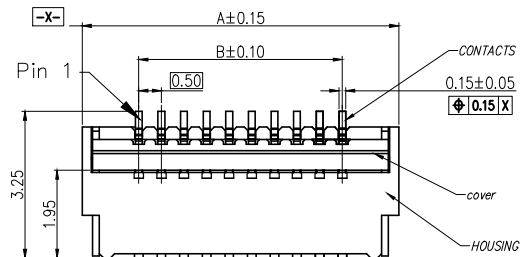
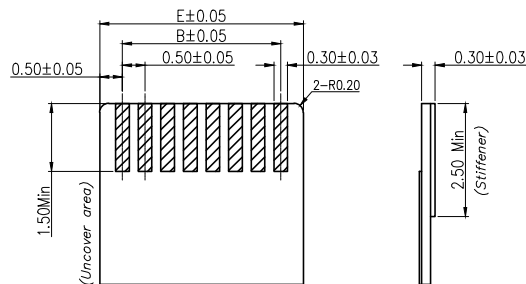
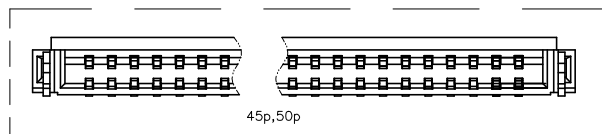
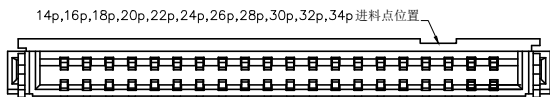
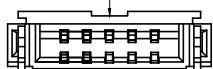


标记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修改 REVISE	日期 DATE	核准 APPROVE



Recommended PCB mounting pattern and metal mask dimensions
Recommended metal mask thickness: $t=0.1$

5p,7p,9p,11p,13p,15p,36p,40p 进料点位置在中心



Recommended FPC/FFC Dimensions

NOTE:

1. MATERIAL:

HOUSING:LCP, COLOR: NATURAL.

CONTACTS: COPPER ALLOY,Au0.025 μ m MIN. Ni 1.0 μ m MIN

PEG: COPPER ALLOY.Sn 2.0 μ m MIN.Ni 1.0 μ m MIN

ACTUATOR:LCP OR PA . COLOR:BLACK

2. RATING:

OPERATING VOLTAGE: 50Vrms AC.

CURRENT RATING: 0.5A.

OPERATING TEMPERATURE: 55°C~+85°C.

OPERATING HUMIDITY RANGE: RELATIVE HUMIDITY 90% MAX.(NO CONDENSATION)

STORAGE TEMPERATURE RANGE: -10°C~+50°C.

STORAGE HUMIDITY RANGE: RELATIVE HUMIDITY 90% MAX.(NO CONDENSATION)

2	端子	铜	点镀金	
1	基座	LCP	本色	
序号	品名	材质	电镀/颜色	备注

 深圳市虹成电子有限公司		品名 TITLE	FPC座	
		料号 PART NO	HC-FPC-0.5-24P-FHH10	
GENERAL TOLERANCES (UNLESS SPECIFIED)		比例 SCALE	1:1	
X.X : ±0.30 X.X' : ±5'		单位 UNIT	MM	制图 DRAW
X.XX : ±0.20 X.XX' : ±2'		张数 PART NO	1 OF 1	审核 CHECKED
		版本 REV	A	批准 APPROVE
				夏操云
				赵亮亮

